Vishay Siliconix



**HVMDIP** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>qs</sub> (nC)

Q<sub>ad</sub> (nC)

Qg (Max.) (nC)

Configuration

# **Power MOSFET**

s

N-Channel MOSFET

1.1

250

14

2.7

7.8

Single

 $V_{GS} = 10 V$ 

## **FEATURES**

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- For automatic Insertion
- End stackable
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serveres as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD224PbF

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unle	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	250	v		
Gate-source voltage			V <sub>GS</sub>	± 20	V	
Continuous drain current	V <sub>GS</sub> at -10 V -	T <sub>A</sub> = 25 °C		0.63		
Continuous drain current	VGS at -10 V	T <sub>A</sub> = 100 °C	I <sub>D</sub>	0.40	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	5.0	1		
Linear derating factor			0.0083	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	60	mJ		
Repetitive avalanche current <sup>a</sup>		I <sub>AR</sub>	0.63	А		
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		PD	1.0	W		
Peak diode recovery dv/dt <sup>c</sup>		dV/dt	4.8	V/ns		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C		
Soldering rRecommendations (peak temperature) d For 10 s			300 <sup>d</sup>			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 15 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.5 A (see fig. 12)

c.  $I_{SD} \le 4.4$  A, dl/dt  $\le 90$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

1 For technical questions, contact: hvm@vishay.com RoHS

COMPLIANT



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μΑ	250	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.36	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
		V <sub>DS</sub> =	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		-	25	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 200 \	$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 ^{\circ}\text{C}$		-	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 0.38 A <sup>b</sup>	-	-	1.1	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 2.6 A	1.5	-	-	S
Dynamic					•		
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	260	-	pF
Output Capacitance	C <sub>oss</sub>		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		77	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	14	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$	I <sub>D</sub> = 4.4 A, V <sub>DS</sub> = 200 V, see fig. 6 and 13 <sup>b</sup>	-	-	2.7	nC
Gate-Drain Charge	Q <sub>gd</sub>		v see fig. 6 and 13 <sup>b</sup> 7.8		7.8		
Turn-On Delay Time	t <sub>d(on)</sub>		·	-	7.0	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	: 125 V, I <sub>D</sub> = 4.4 A,	-	13	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 18 \Omega$ ,	$R_D = 28 \Omega$ , see fig. $10^b$	-	20	-	ns
Fall Time	t <sub>f</sub>			-	12	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.0	-	
Internal Source Inductance	L <sub>S</sub>	<ul> <li>package and die contact</li> </ul>		- 4.0 - nH			
Drain-Source Body Diode Characteristics					•		•
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	0.63	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction		-	-	5.0	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$I_{\rm S} = 0.63$ A, $V_{\rm GS} = 0$ V <sup>b</sup>	-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	<b>T</b>		-	200	400	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>.1</sub> = 25 °C, I <sub>F</sub> = 4.4 A, dl/dt = 100 A/μs <sup>b</sup>		1.9	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	Irn-on time is negligible (turn	-on is dor	ninated b	$_{\rm by \ L_{\rm S}}$ and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

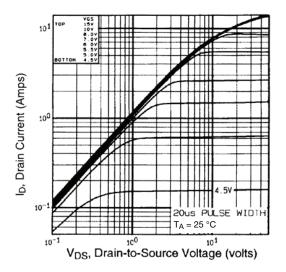


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

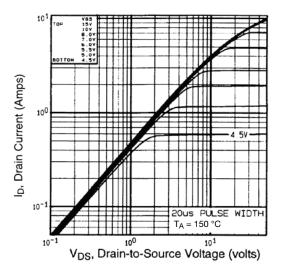


Fig. 1 - Typical Output Characteristics,  $T_A = 150 \ ^{\circ}C$ 

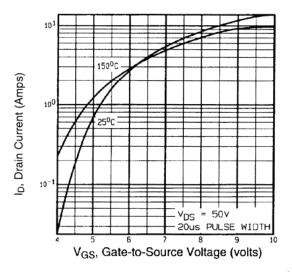


Fig. 2 - Typical Transfer Characteristics

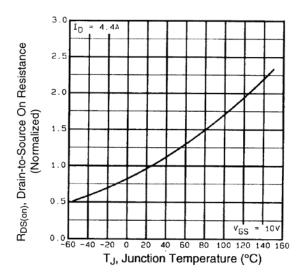


Fig. 3 - Normalized On-Resistance vs. Temperature



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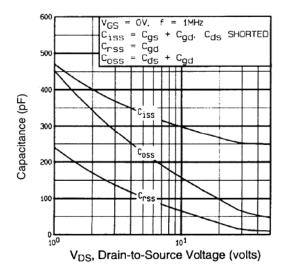


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

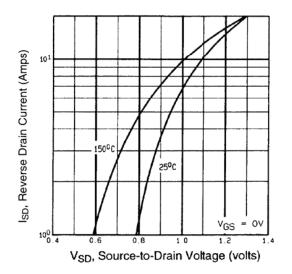


Fig. 6 - Typical Source-Drain Diode Forward Voltage

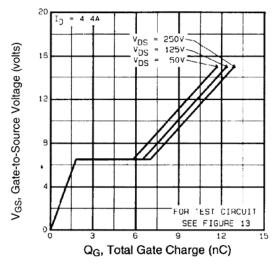
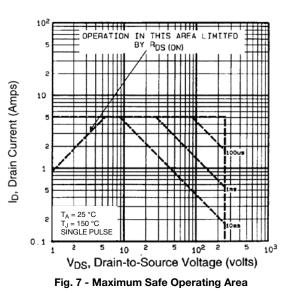


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage



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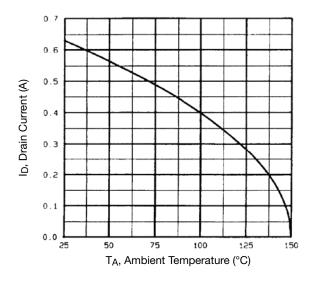


Fig. 8 - Maximum Drain Current vs. Ambient Temperature

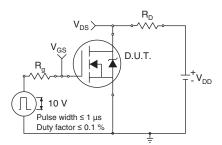


Fig. 10a - Switching Time Test Circuit

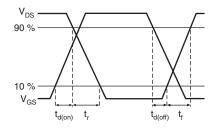


Fig. 10b - Switching Time Waveforms

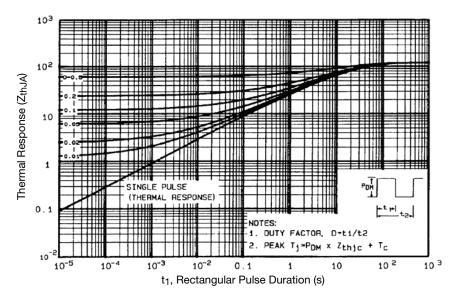


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



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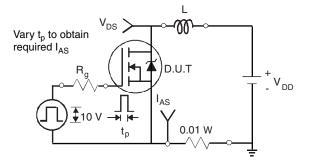


Fig. 12a - Unclamped Inductive Test Circuit

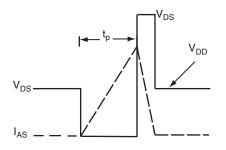


Fig. 12b - Unclamped Inductive Waveforms

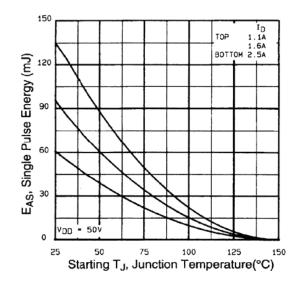


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

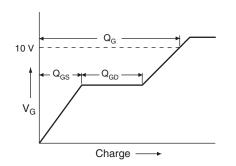


Fig. 13a - Basic Gate Charge Waveform

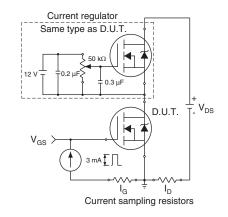


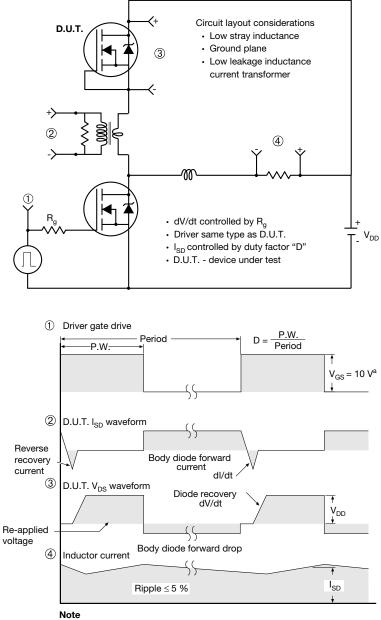
Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS}$  = 5 V for logic level devices

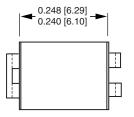
Fig. 10 - For N-Channel

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### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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